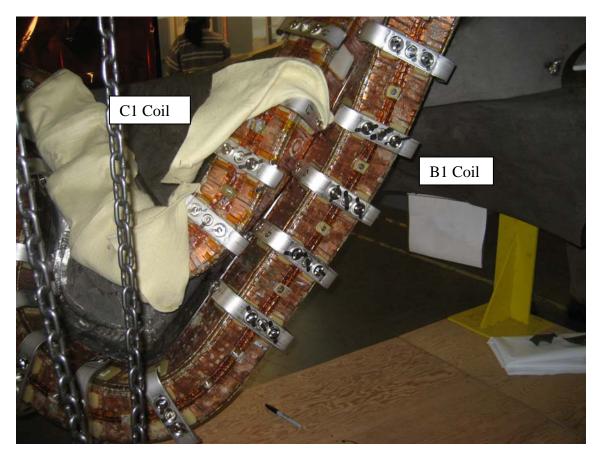
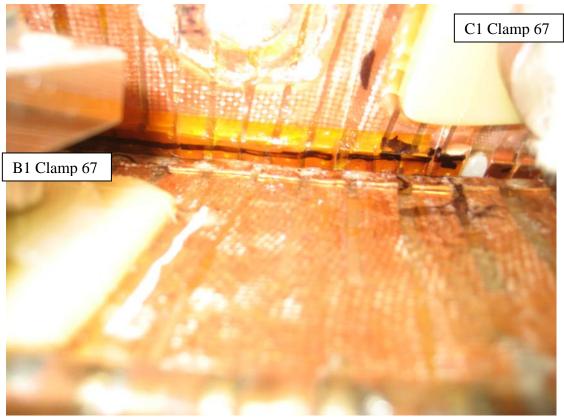
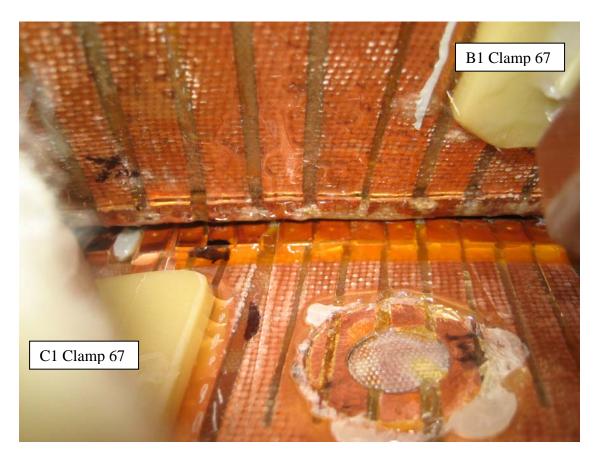
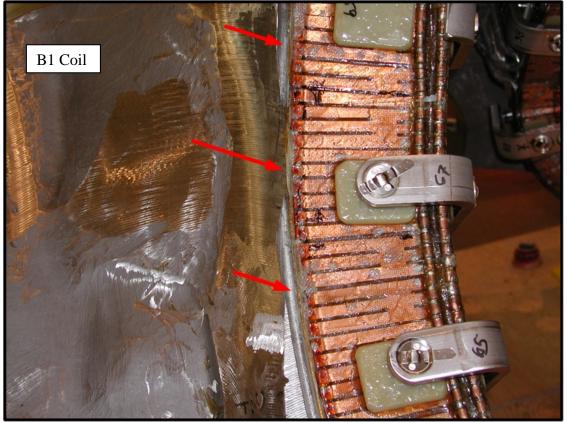
PPPL NONCON	FORMANCE REPORT	NO: 3735	Open D	ate 11/15/0						
· · · · · · · · · · · · · · · · · · ·	5-Corrective Action Needed		Trend	05-Design Inte	erferance					
	NCSX		Division	WBS 142						
Source/Org	Fabrication, Operations & Mair	ntenance								
Item Dwg/Part#	b1_mtm_data_check.asm	Procurement #	WPF-12	224	_ Cost Cente	er				
RAP# 3304	Job Doc # WPF-1224	Vendor								
RAP Title Coil to	Coil Assembly Trials									
☐ HoldTag App	lied									
Nonconforming Condition (include requirement(s) violated):										
#67. The interference	ring the trial fit-up of the B1 ar ce is between the copper chill pase cladding, see attachment	plates of each coil jus								
Lot Size Recd _ Reported By Ch	<u>0</u> Sample Size	e Insp 0	s C	Lot Rejected	# Reje	ected 0 11/15/07				
Disposition: Rewor	k* Repair* Use As Is*_	Return To Vendo	r* Scrap) *						
	Please use p. 2 t	or disposition a	nd appro	vals .						
For rework or repair	of vendor supplied equipme	ents, fill in informati	on below:		Distr	ibution				
#Hours	\$Est Labor	. \$	G&A		Cog					
\$Material	\$Burden		Total		Insp Proj. close	Doc Control (when				
Disposition By				Date	QC F	iles				
Supervisor's Con	cur			Date	Malsk Bosco	oury J				
Eng. Dept. Head (Concur			Date		rzanowski				
WCO/Other				Date	M. Vi					
					Brow	enroeder P n T				
						ıms M				
PQA/QC Mgr Disp	oos Concur			Date	Simm Tyrre	nons B				
QC Field Verificat				Date	Tyrite	II IVI				

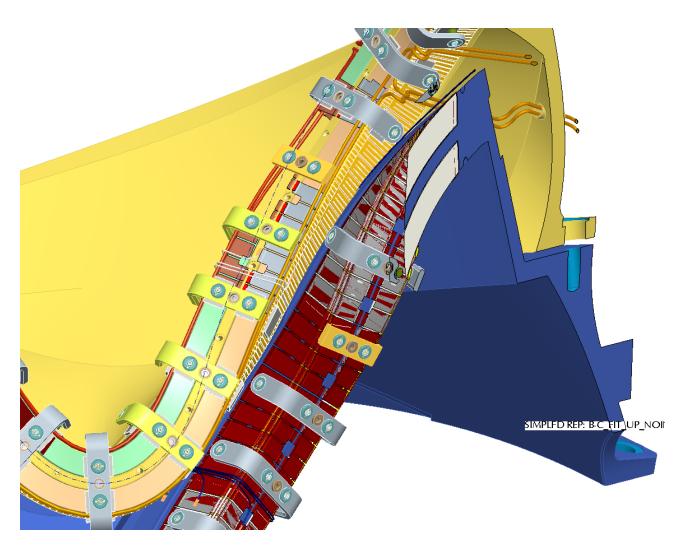
Disposition:	Rework	Repair	Use As Is	Return to Vendor	Scrap				
For rework or	r repair of vend	or supplied e	equipment, fill in	information below:					
# Hours \$ Est Lab		or	\$ G&A						
\$ Mate	erial	\$ Burden		\$ Total					
Disposition b	у								
Supervisor's	Concurrence								
Eng. Dept. Head Concurrence									
Other (i.e., WCO/FPE) Concurrence									
PQA/QC Mgr	Disposition Co	ncurrence							
QA Field Veri	fication by								
					p. 2				











Portion of master machine model identified as "bl_mtm_data_check.asm" which brings together the top level MC assemblies, sel41-102 and -103 which include the MC Type-B and Type-C details.